PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|-----------------------|----------------|
| JEAN-PHILIPPE LAMBOUX | 08/18/2020 |

RECEIVING PARTY DATA

| Name: | TECHNIPLAST | |
|-----------------|----------------|--|
| Street Address: | 8, RUE DE LÉRY | |
| City: | LOUVIERS | |
| State/Country: | FRANCE | |
| Postal Code: | 27400 | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 16986537 |

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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|-------------------------|----------------|
| NAME OF SUBMITTER: | JOSEPH SOFER |
| SIGNATURE: | /Joseph Sofer/ |
| DATE SIGNED: | 05/10/2022 |

Total Attachments: 2

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PATENT 507276408 REEL: 059885 FRAME: 0159

ASSIGNMENT AND AGREEMENT

For value received, I, Jean-Philippe LAMBOUX of 38, Rue d'Elbeuf 27370 Saint Didier des Bois, France, hereby sell, assign and transfer to TECHNIPLAST having a place of business at 8, rue de Léry 27400 LOUVIERS, France; and their successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to

METHOD FOR THE RE-FILLING OF A TRAVEL DISPENSER WITH PRODUCT AND TRAVEL DISPENSER

described in application no.: 16/986,537 (U.S Patent Application); all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions, including continuation, divisional and continuation-in-part applications.

I authorize TECHNIPLAST to make application for such protection in its own name and maintain such protection in the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of TECHNIPLAST to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to TECHNIPLAST in the United States, or to such nominees as TECHNIPLAST may designate.

I agree that, when requested, I shall, without charge to TECHNIPLAST, but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection. I further grant TECHNIPLAST the right and the ability to sign such papers required for the execution of such papers in the case we are unavailable or not-contactable for such signature(s).

I HEREBY declare the following:

- (1) the above identified application was made or was authorized to be made by me; and
- (2) I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

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I acknowledge that any willful false statement made in such declaration or statement is punishable under section 1001 of title 18 by fine or imprisonment of not more than 5 years, or both.

Date: 18.08.2020

Jean-Philippe I AMBOUX

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RECORDED: 05/10/2022